## : ©hipsmall

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## BUL146G, BUL146FG

## SWITCHMODE ${ }^{\text {m }}$ NPN Bipolar Power Transistor For Switching Power Supply Applications

The BUL146G / BUL146FG have an applications specific state-of-the-art die designed for use in fluorescent electric lamp ballasts to 130 W and in Switchmode Power supplies for all types of electronic equipment.

## Features

- Improved Efficiency Due to Low Base Drive Requirements:
- High and Flat DC Current Gain
- Fast Switching
- No Coil Required in Base Circuit for Turn-Off (No Current Tail)
- Full Characterization at $125^{\circ} \mathrm{C}$
- Two Packages Choices: Standard TO-220 or Isolated TO-220
- Parametric Distributions are Tight and Consistent Lot-to-Lot
- BUL146F, Case 221D, is UL Recognized to 3500 V RMS : File \# E69369
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant*


## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-Emitter Sustaining Voltage | $\mathrm{V}_{\text {CEO }}$ | 400 | Vdc |
| Collector-Base Breakdown Voltage | $\mathrm{V}_{\text {CES }}$ | 700 | Vdc |
| Emitter-Base Voltage | $\mathrm{V}_{\text {EBO }}$ | 9.0 | Vdc |
| $\begin{array}{ll} \hline \text { Collector Current } & - \text { Continuous } \\ & - \text { Peak (Note 1) } \end{array}$ | $\begin{gathered} \mathrm{I}_{\mathrm{C}} \\ \mathrm{I}_{\mathrm{CM}} \end{gathered}$ | $\begin{aligned} & 6.0 \\ & 15 \end{aligned}$ | Adc |
| Base Current <br> - Continuous <br> - Peak (Note 1) | $\begin{gathered} \mathrm{I}_{\mathrm{B}} \\ \mathrm{I}_{\mathrm{BM}} \end{gathered}$ | $\begin{aligned} & 4.0 \\ & 8.0 \end{aligned}$ | Adc |
| RMS Isolation Voltage (Note 2) (for 1 sec, R.H. $<30 \%, \mathrm{~T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ ) | $V_{\text {ISOL1 }}$ <br> VISOL2 <br> $V_{\text {ISOL3 }}$ | $\begin{gathered} \text { BUL146F } \\ 4500 \\ 3500 \\ 1500 \end{gathered}$ | V |
| Total Device Dissipation @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$  <br> BUL146  <br> BUL146F  <br> Derate above $25^{\circ} \mathrm{C}$ BUL146 <br>  BUL146F | $\mathrm{P}_{\mathrm{D}}$ | $\begin{gathered} 100 \\ 40 \\ 0.8 \\ 0.32 \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~W} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Operating and Storage Temperature | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Case |  |  |  |
| BUL146 <br> BUL146F | $\mathrm{R}_{\theta \mathrm{JC}}$ |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\theta \mathrm{JA}}$ | 62.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Lead Temperature for Soldering <br> Purposes 1/8" from Case for 5 Seconds | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width $=5 \mathrm{~ms}$, Duty Cycle $\leq 10 \%$.
2. Proper strike and creepage distance must be provided.

## ON Semiconductor ${ }^{\text {® }}$

http://onsemi.com

| POWER TRANSISTOR |
| :---: |
| 8.0 AMPERES |
| 1000 VOLTS |
| 45 and 125 WATTS |



## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

[^0]ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS |  |  |  |  |  |
| Collector-Emitter Sustaining Voltage ( $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~L}=25 \mathrm{mH}$ ) | $\mathrm{V}_{\text {CEO }}$ (sus) | 400 | - | - | Vdc |
| Collector Cutoff Current ( $\mathrm{V}_{\mathrm{CE}}=$ Rated $\left.\mathrm{V}_{\mathrm{CEO}}, \mathrm{I}_{\mathrm{B}}=0\right)$ | ICEO | - | - | 100 | $\mu \mathrm{Adc}$ |
| Collector Cutoff Current ( $\mathrm{V}_{\mathrm{CE}}=$ Rated $\mathrm{V}_{\mathrm{CES}}, \mathrm{V}_{\mathrm{EB}}=0$ ) $\left(\mathrm{V}_{\mathrm{CE}}=500 \mathrm{~V}, \mathrm{~V}_{\mathrm{EB}}=0\right)$ $\begin{aligned} & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \end{aligned}$ | $I_{\text {CES }}$ | - | - | $\begin{aligned} & 100 \\ & 500 \\ & 100 \end{aligned}$ | $\mu \mathrm{Adc}$ |
| Emitter Cutoff Current ( $\left.\mathrm{V}_{\mathrm{EB}}=9.0 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=0\right)$ | $\mathrm{I}_{\text {EBO }}$ | - | - | 100 | $\mu \mathrm{Adc}$ |

## ON CHARACTERISTICS

| $\begin{array}{ll} \text { Base-Emitter Saturation Voltage } & \left(\mathrm{I}_{\mathrm{C}}=1.3 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.13 \mathrm{Adc}\right) \\ & \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.6 \mathrm{Adc}\right) \end{array}$ | $\mathrm{V}_{\mathrm{BE} \text { (sat) }}$ |  | $\begin{aligned} & 0.82 \\ & 0.93 \end{aligned}$ | $\begin{gathered} 1.1 \\ 1.25 \end{gathered}$ | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Collector-Emitter Saturation Voltage $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=1.3 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.13 \mathrm{Adc}\right) \\ & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ & \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.6 \mathrm{Adc}\right) \\ & \quad\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{V}_{\text {CE(sat) }}$ | - | $\begin{aligned} & 0.22 \\ & 0.20 \\ & 0.30 \\ & 0.30 \end{aligned}$ | $\begin{aligned} & 0.5 \\ & 0.5 \\ & 0.7 \\ & 0.7 \end{aligned}$ | Vdc |
| DC Current Gain $\begin{array}{ll} \hline\left(I_{C}=0.5 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}\right) & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ \left(\mathrm{I}_{\mathrm{C}}=1.3 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=1.0 \mathrm{Vdc}\right) & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=1.0 \mathrm{Vdc}\right) & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ \left(\mathrm{I}_{\mathrm{C}}=10 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}\right) & \\ \hline \end{array}$ | $\mathrm{h}_{\text {FE }}$ | 14 - 12 12 8.0 7.0 10 | $\begin{aligned} & 30 \\ & 20 \\ & 20 \\ & 13 \\ & 12 \\ & 20 \end{aligned}$ | 34 <br> - <br> - <br> - | - |

DYNAMIC CHARACTERISTICS

| Current Gain Bandwidth ( $\mathrm{l}_{\mathrm{C}}=0.5 \mathrm{Adc}, \mathrm{V}_{\text {CE }}=10 \mathrm{Vdc}, \mathrm{f}=1.0 \mathrm{MHz}$ ) |  |  |  | $\mathrm{f}_{\text {T }}$ | - | 14 | - | MHz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Capacitance ( $\mathrm{V}_{\mathrm{CB}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{E}}=0, \mathrm{f}=1.0 \mathrm{MHz}$ ) |  |  |  | $\mathrm{C}_{\mathrm{OB}}$ | - | 95 | 150 | pF |
| Input Capacitance ( $\mathrm{V}_{\mathrm{EB}}=8.0 \mathrm{~V}$ ) |  |  |  | $\mathrm{C}_{\text {IB }}$ | - | 1000 | 1500 | pF |
| Dynamic Saturation Voltage: Determined $1.0 \mu \mathrm{~s}$ and $3.0 \mu \mathrm{~s}$ respectively after rising $\mathrm{I}_{\mathrm{B} 1}$ reaches $90 \%$ of final $l_{B 1}$ (see Figure 18) | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=1.3 \mathrm{Adc}\right. \\ & \mathrm{I}_{\mathrm{B} 1}=300 \mathrm{mAdc} \\ & \left.\mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | $1.0 \mu \mathrm{~s}$ | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{V}_{\text {CE (dsat) }}$ | - | $\begin{aligned} & 2.5 \\ & 6.5 \end{aligned}$ |  | V |
|  |  | $3.0 \mu \mathrm{~s}$ | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ |  | - | $\begin{aligned} & 0.6 \\ & 2.5 \end{aligned}$ | - |  |
|  | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}\right. \\ & \mathrm{I}_{\mathrm{B} 1}=0.6 \mathrm{Adc} \\ & \left.\mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | $1.0 \mu \mathrm{~s}$ | ( $\left.\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ |  | - | $\begin{aligned} & 3.0 \\ & 7.0 \end{aligned}$ | - |  |
|  |  | $3.0 \mu \mathrm{~s}$ | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ |  | - | $\begin{gathered} \hline 0.75 \\ 1.4 \end{gathered}$ | - |  |

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted) (continued)

| Characteristic |  |  | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SWITCHING CHARACTERISTICS: Resistive Load (D.C. $\leq 10 \%$, Pulse Width $=20 \mu \mathrm{~s}$ ) |  |  |  |  |  |  |  |
| Turn-On Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=1.3 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.13 \mathrm{Adc}\right. \\ & \left.\mathrm{I}_{\mathrm{B} 2}=0.65 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\text {on }}$ | - | $\begin{gathered} 100 \\ 90 \end{gathered}$ | 200 - | ns |
| Turn-Off Time |  | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\text {off }}$ | - | $\begin{aligned} & 1.35 \\ & 1.90 \end{aligned}$ | 2.5 - | $\mu \mathrm{s}$ |
| Turn-On Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.6 \mathrm{Adc}\right. \\ & \left.\mathrm{I}_{\mathrm{B} 1}=1.5 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\text {on }}$ | - | $\begin{gathered} 90 \\ 100 \end{gathered}$ | 150 - | ns |
| Turn-Off Time |  | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\text {off }}$ | - | $\begin{aligned} & 1.7 \\ & 2.1 \end{aligned}$ | 2.5 - | $\mu \mathrm{s}$ |

SWITCHING CHARACTERISTICS: Inductive Load ( $\mathrm{V}_{\text {clamp }}=300 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{~L}=200 \mu \mathrm{H}$ )

| Fall Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=1.3 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.13 \mathrm{Adc}\right. \\ & \left.\mathrm{I}_{\mathrm{B} 2}=0.65 \mathrm{Adc}\right) \end{aligned}$ | ( $\left.\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{fi}}$ | - | $\begin{aligned} & 115 \\ & 120 \end{aligned}$ | 200 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Storage Time |  | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\text {si }}$ | - | 1.35 1.75 | 2.5 - | $\mu \mathrm{s}$ |
| Crossover Time |  | ( $\left.\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{c}}$ | - | $\begin{aligned} & 200 \\ & 210 \end{aligned}$ | 350 - | ns |
| Fall Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.6 \mathrm{Adc}\right. \\ & \left.\mathrm{I}_{\mathrm{B} 2}=1.5 \mathrm{Adc}\right) \end{aligned}$ | ( $\left.\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | tfi | - | $\begin{gathered} 85 \\ 100 \end{gathered}$ | 150 - | ns |
| Storage Time |  | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{si}}$ | - | $\begin{aligned} & 1.75 \\ & 2.25 \end{aligned}$ | 2.5 | $\mu \mathrm{s}$ |
| Crossover Time |  | ( $\left.T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{c}}$ | - | $\begin{aligned} & 175 \\ & 200 \end{aligned}$ | 300 - | ns |
| Fall Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=3.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.6 \mathrm{Adc}\right. \\ & \left.\mathrm{I}_{\mathrm{B} 2}=0.6 \mathrm{Adc}\right) \end{aligned}$ | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $t_{\text {fi }}$ | $80$ | $2 \overline{210}$ | 180 | ns |
| Storage Time |  | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{si}}$ | 2.6 | - 4. | 3.8 | $\mu \mathrm{s}$ |
| Crossover Time |  | ( $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ ) | $\mathrm{t}_{\mathrm{c}}$ | - | $\begin{aligned} & 230 \\ & 400 \end{aligned}$ | 350 | ns |

## BUL146G, BUL146FG

TYPICAL STATIC CHARACTERISTICS


Figure 1. DC Current Gain @ 1 Volt


Figure 3. Collector Saturation Region


Figure 5. Base-Emitter Saturation Region


Figure 2. DC Current Gain @ 5 Volts


Figure 4. Collector-Emitter Saturation Voltage


Figure 6. Capacitance

## BUL146G, BUL146FG

TYPICAL SWITCHING CHARACTERISTICS
( $\mathrm{I}_{\mathrm{B} 2}=\mathrm{I}_{\mathrm{C}} / 2$ for all switching)


Figure 7. Resistive Switching, $\mathrm{t}_{\mathrm{on}}$


Figure 9. Inductive Storage Time, $\mathbf{t}_{\mathbf{s i}}$


Figure 11. Inductive Switching, $\mathrm{t}_{\mathrm{c}}$ and $\mathrm{t}_{\mathrm{fi}}$ $I_{C} / I_{B}=5$


Figure 8. Resistive Switching, $\mathrm{t}_{\text {off }}$


Figure 10. Inductive Storage Time, $\mathbf{t}_{\mathbf{s i}}\left(\mathrm{h}_{\mathrm{FE}}\right)$


Figure 12. Inductive Switching, $\mathrm{t}_{\mathrm{c}}$ and $\mathrm{t}_{\mathrm{fi}}$ $\mathrm{I}_{\mathrm{C}} / \mathrm{I}_{\mathrm{B}}=10$

## BUL146G, BUL146FG

## TYPICAL SWITCHING CHARACTERISTICS

( $\mathrm{I}_{\mathrm{B} 2}=\mathrm{I}_{\mathrm{C}} / 2$ for all switching $)$


Figure 13. Inductive Fall Time


Figure 14. Inductive Cross-Over Time

GUARANTEED SAFE OPERATING AREA INFORMATION


Figure 15. Forward Bias Safe Operating Area

Figure 17. Forward Bias Power Derating


Figure 16. Reverse Bias Switching Safe Operating Area
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $\mathrm{I}_{\mathrm{C}}-\mathrm{V}_{\mathrm{CE}}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} ; \mathrm{T}_{\mathrm{J}(\mathrm{pk})}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to $10 \%$ but must be derated when $\mathrm{T}_{\mathrm{C}}>25^{\circ} \mathrm{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17. $\mathrm{T}_{\mathrm{J}(\mathrm{pk})}$ may be calculated from the data in Figure 20. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reversebiased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

## BUL146G, BUL146FG



Figure 18. Dynamic Saturation Voltage Measurements


Figure 19. Inductive Switching Measurements


Table 1. Inductive Load Switching Drive Circuit

## BUL146G, BUL146FG

## TYPICAL THERMAL RESPONSE



Figure 20. Typical Thermal Response ( $\mathrm{Z}_{\theta \mathrm{JC}}(\mathrm{t})$ ) for BUL146


Figure 21. Typical Thermal Response for BUL146F

ORDERING INFORMATION

| Device | Package | Shipping |
| :---: | :---: | :---: |
| BUL146G | TO-220AB <br> (Pb-Free) | 50 Units / Rail |
| BUL146FG | TO-220 (Fullpack) <br> (Pb-Free) | 50 Units / Rail |

## BUL146G, BUL146FG

TEST CONDITIONS FOR ISOLATION TESTS*


Figure 22a. Screw or Clip Mounting Position for Isolation Test Number 1
*Measurement made between leads and heatsink with all leads shorted together

MOUNTING INFORMATION**


Figure 23a. Screw-Mounted


Figure 23b. Clip-Mounted

Figure 23. Typical Mounting Techniques

## for Isolated Package

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to $8 \mathrm{in} \cdot \mathrm{lbs}$ is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of $20 \mathrm{in} \cdot \mathrm{lbs}$ will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in • Ibs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding $10 \mathrm{in} \cdot \mathrm{lbs}$ of mounting torque under any mounting conditions.

[^1]
## BUL146G, BUL146FG

## PACKAGE DIMENSIONS

TO-220AB
CASE 221A-09
ISSUE AF


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH. BODY AND LEAD IRREGULARITIES ARE BODY AND

|  | INCHES |  | MILLIMETERS |  |
| :---: | :---: | ---: | ---: | ---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.405 | 9.66 | 10.28 |
| C | 0.160 | 0.190 | 4.07 | 4.82 |
| D | 0.025 | 0.035 | 0.64 | 0.88 |
| F | 0.142 | 0.161 | 3.61 | 4.09 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.155 | 2.80 | 3.93 |
| J | 0.014 | 0.025 | 0.36 | 0.64 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

TO-220 FULLPAK
CASE 221D-03
ISSUE G


NOTES:
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03

|  | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 0.625 | 0.635 | 15.88 | 16.12 |
| B | 0.408 | 0.418 | 10.37 | 10.63 |
| C | 0.180 | 0.190 | 4.57 | 4.83 |
| D | 0.026 | 0.031 | 0.65 | 0.78 |
| F | 0.116 | 0.119 | 2.95 | 3.02 |
| G | 0.100 | $0.15 C$ | 2.54 BSC |  |
| H | 0.125 | 0.135 | 3.18 |  |
| J | 0.018 | 0.025 | 0.45 | 0.63 |
| K | 0.530 | 0.540 | 13.47 | 13.73 |
| L | 0.048 | 0.053 | 1.23 | 1.36 |
| N | 0.200 BSC | 5.08 BSC |  |  |
| Q | 0.124 | 0.128 |  |  |
| R | 0.099 | 0.103 | 2.15 | 3.25 |
| S | 0.101 | 0.113 | 2.51 | 2.62 |
| U | 0.238 | 0.258 | 6.06 | 6.56 |

STYLE 2:
PIN 1. BASE
2. COLLECTOR
3. EMITTER

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[^0]:    *For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

[^1]:    ** For more information about mounting power semiconductors see Application Note AN1040.

